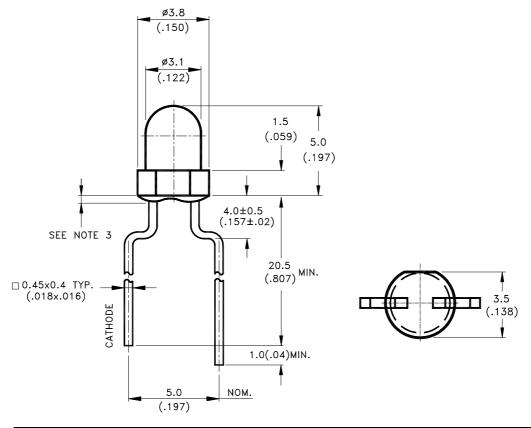


Property of Lite-On Only

Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * 3.1 mm diameter package.

Package Dimensions



Part No.	Part No. Lens	
LTL1KHCBP7T-011A	Blue Transparent	Blue InGaN

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Part No.: LTL1KHCBP7T-011A	Page:	1	of	11	
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Property of Lite-On Only

Absolute Maximum Ratings at Ta=25℃

Parameter	Maximum Rating U	
Power Dissipation	126 m	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
DC Forward Current	30	mA
Operating Temperature Range	-40°C to + 85°C	
Storage Temperature Range	-40°C to + 100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

Part No.: LTL1KHCBP7T-011A Page: 2 of 11



Property of Lite-On Only

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	520		1500	mcd	I _F = 20mA Note 1
Viewing Angle	201/2		75		deg	Note 2 (Fig.5)
Peak Emission Wavelength	$\lambda_{ m P}$		468		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd		470		nm	Note 4
Spectral Line Half-Width	Δλ		26		nm	
Forward Voltage	VF		3.3	4.2	V	I _F = 20mA
Reverse Current	I_R			10	μΑ	$V_R = 5V$

- NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
 - 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
 - 3. Iv classification code is marked on each packing bag.
 - 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
 - 5. Reverse voltage (V_R) condition is applied for IR test only. The device is not designed for reverse operation.

Part No.: LTL1KHCBP7T-011A	Page:	3	of	11	
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Property of Lite-On Only

Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

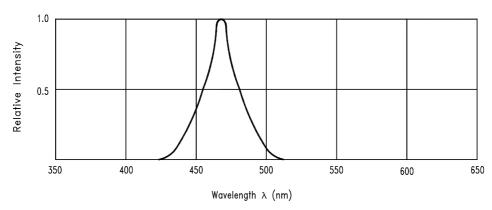
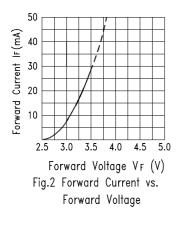
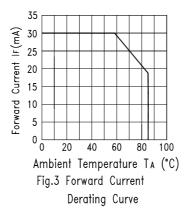
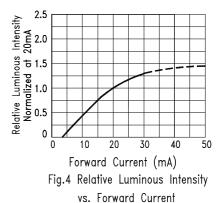
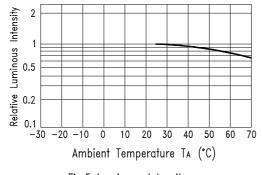


Fig.1 Relative Intensity vs. Wavelength









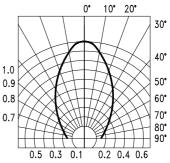


Fig.6 Spatial Distribution

Fig.5 Luminous Intensity vs.

Ambient Temperature

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LITEON

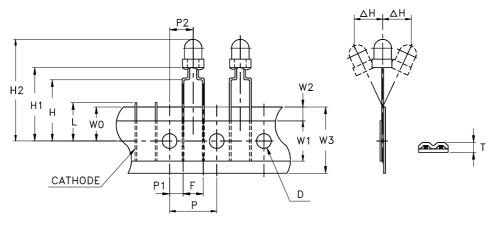
LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

Features

- * Compatible with radial lead automatic insertion equipment.
- * Most radial lead plastic lead lamps available packaged in tape and folding.
- * 5mm (0.197") formed lead spacing available.
- * Folding packaging simplifies handling and testing.
- * Reel packing is available by removing suffix "A" on option.

Package Dimensions



TAPE	FEED	DIRECTIO	Ν

		Specification			
Item	Symbol	Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	4.8	0.188	5.8	0.228
Front to Rear Deflection	ΔΗ	I	1	2.0	0.078
Height of Seating Plane	Н	15.5	0.610	16.5	0.649
Feed Hole to Bottom of Component	H1	19.0	0.748	21.0	0.827
Feed Hole to Overall Component Height	H2	23.7	0.933	26.3	1.035
Lead Length After Component Height	L	W0		11.0	0.433
Feed Hole Pitch	P	12.4	0.488	13.0	0.511
Lead Location	P1	3.15	0.124	4.55	0.179
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Taped Thickness	Т			0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748

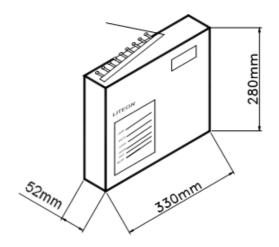
Part No.: LTL1KHCBP7T-011A Page: 5 of 11



Property of Lite-On Only

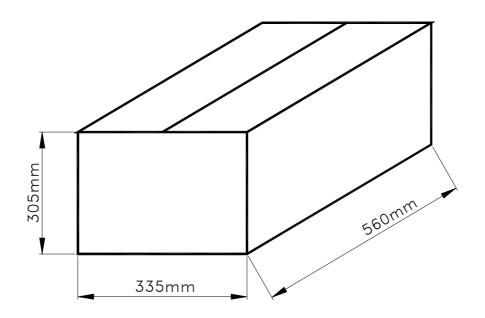
Packing Spec

3,000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton total 30,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL1KHCBP7T-011A Page: 6 of 11



Property of Lite-On Only

Bin Code List For Reference

Luminous Inte	t : mcd @20mA	
Bin Code	Min.	Max.
M	520	680
N	680	880
P	880	1150
Q	1150	1500

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength		Unit: nm @20mA		
Bin Code	Min.	Max.		
B08	465.0	470.0		
B09	470.0	475.0		

Note: Tolerance of each bin limit is ± 1 nm

Part No.: LTL1KHCBP7T-011A Page: 7 of 11



Property of Lite-On Only

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	350°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

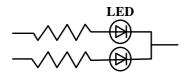
Part No.: LTL1KHCBP7T-011A Page: 8 of 11

Property of Lite-On Only

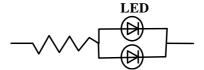
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No.: LTL1KHCBP7T-011A Page: 9 of 11



Property of Lite-On Only

Suggested checking list:

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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Property of Lite-On Only

8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life (LT)	Ta = under room temperature IF = per datasheet maximum drive current *Test time = 1000 hrs	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
Endurance	High temperature/ High humidity storage (THB)	Ta = 60 °C RH = 90% Test time = 240hrs	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Test High temperature storage		$Ta = 105 \pm 5^{\circ}C$ $Test time = 1000 hrs$	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low temperature storage	$Ta = -55 \pm 5^{\circ}C$ $Test time = 1000 hrs$	JEITA ED-4701: 200 202 (2001)
	Temperature cycling	100°C ~ 25°C ~ -40°C ~ 25°C 30 mins 5 mins 30 mins 5 mins 30 cycles	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal shock	100 ± 5°C ~ -30 ± 5°C 15 mins 15 mins 30 cycles (< 20 secs transfer)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Environmental Test	Solder resistance (no pre-condition)	$T.sol = 260 \pm 5$ °C Dwell time = 10 ± 1 sec 3mm from the base of the epoxy bulb	MIL-STD-750D:2031 (1995) JEITA ED-4701: 300 302 (2001)
	Solderability (no pre-condition)	$T.sol = 245 \pm 5^{\circ}C$ Dwell time = 5 ± 0.5 sec	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron (no pre-condition)	T.sol = $350 \pm 5^{\circ}$ C Dwell time = 3.5 ± 0.5 sec	MIL-STD-202G:208H (2002) JEITA ED-4701: 300 302 (2001)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.